

## C2220C104K5TACTU

Aliases (C2220C104K5TAC7800) SMD Comm X8G HT150C, Ceramic, 0.1 uF, 10%, 50 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 2220, 3.5 mm



Click here for the 3D model.

General Information		
Series	SMD Comm X8G HT150C	
Style	SMD Chip	
Description	SMD, MLCC, High Temperature, Ultra-Stable	
Features	High Temperature, Ultra-Stable	
RoHS	Yes	
Termination	Tin	
Marking	No	
AEC-Q200	No	
Typical Component Weight	130 mg	
Shelf Life	78 Weeks	
MSL	1	

Dimensions		Specifications
Chip Size	2220	Capacitance
L	5.7mm +/-0.4mm	Measurement Conditio
W	5mm +/-0.4mm	Tolerance
т	1mm +/-0.15mm	Voltage DC
S	3.5mm MIN	Dielectric Withstanding
В	0.6mm +/-0.35mm	Temperature Range
		Temp. Coefficient
Packaging Specifications		Capacitance Change w

Packaging Specifications		
Packaging	T&R, 180mm, Plastic Tape	
Packaging Quantity	1000	

Specifications	
Capacitance	0.1 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	50 VDC
Dielectric Withstanding Voltage	125 VDC
Temperature Range	-55/+150°C
Temp. Coefficient	X8G
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	10 GOhms

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